



TITLE: SEMICONDUCTOR DEVICE WITH
IMPROVED BOND PADS
Inventor: Rodney C. Langley
Serial No.: 09/438,692
Docket No.: 2269-3656US
REPLACEMENT SHEET

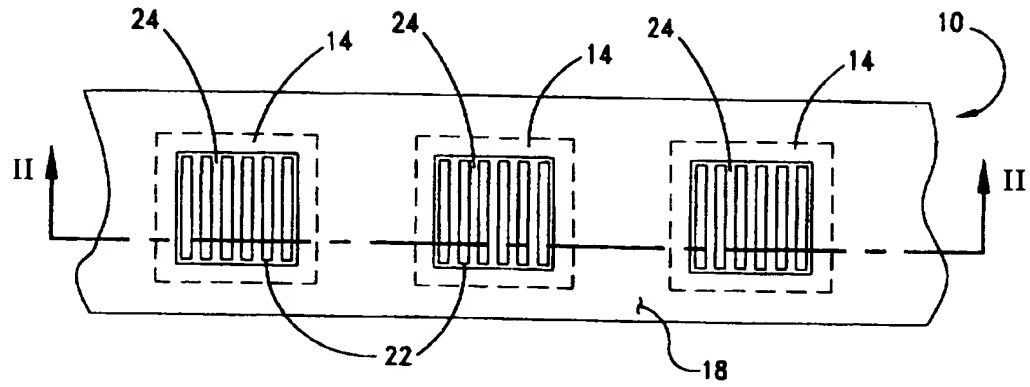


FIG. 1
(AMENDED)

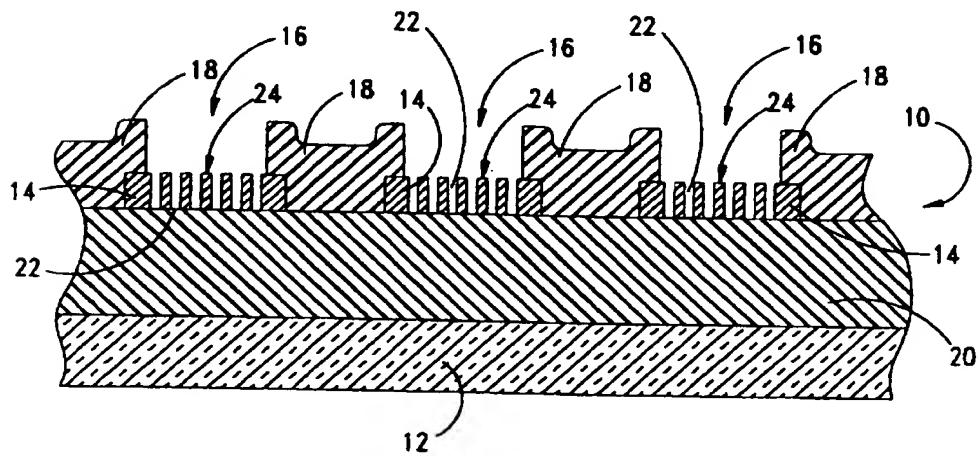


FIG. 2